

**Vishay Siliconix** 

# N-Channel 30-V (D-S) MOSFET with Schottky Diode

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
30	0.0030 at V <sub>GS</sub> = 10 V	38	27.5 nC			
50	0.0038 at V <sub>GS</sub> = 4.5 V	33	27.5110			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- SkyFET<sup>®</sup> Monolithic TrenchFET<sup>®</sup> Gen III Power MOSFET and Schottky Diode
   100 % R<sub>g</sub> and UIS Tested

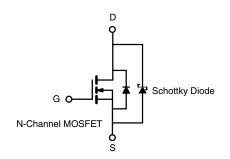
COMPLIANT HALOGEN

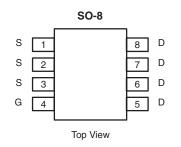
RoHS

Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

- Notebook CPU Core
- Buck Converter





Ordering Information: Si4628DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	30	V		
Gate-Source Voltage	V <sub>GS</sub>	± 20			
	T <sub>C</sub> = 25 °C		38	- A	
Continuous Drain Current ( $T_1 = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	1-	30		
Continuous Diain Ourient (1j = 150°C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	25.4 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		20 <sup>b, c</sup>		
Pulsed Drain Current		I <sub>DM</sub>	70		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	L.	7		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.1 <sup>b, c</sup>		
Single Pulse Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	45		
Single Pulse Avalanche Energy		E <sub>AS</sub>	101	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum Bower Dissinction	T <sub>C</sub> = 70 °C	PD	5	w	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	۲D -	3.5 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>	7	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Тур.	Max.	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	13	16	0/10		

Notes:

a. Based on T<sub>C</sub> = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under Steady State conditions is 80 °C/W.

## Si4628DY

# Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					<u> </u>		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 1 mA$	30			V	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.0		2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	0.10 0.25		0.25		
		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 100 ^{\circ}\text{C}$		7.5	70	– mA	
On -State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \geq 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	40			Α	
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.0024	0.0030	Ω	
Drain-Source On-State Resistance <sup>a</sup>		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.0030	0.0038		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 20 A		73		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			3450		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		810			
Reverse Transfer Capacitance	C <sub>rss</sub>	1		260			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		58	87		
				27.5	42	nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{\text{DS}}$ = 15 V, $V_{\text{GS}}$ = 4.5 V, $I_{\text{D}}$ = 20 A		8.3		nc	
Gate-Drain Charge	Q <sub>gd</sub>			7.5			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	1.7	3.4	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			28	55		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		20	40		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 4.5 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		39	75		
Fall Time	t <sub>f</sub>	1		13	26		
Turn-On Delay Time	t <sub>d(on)</sub>			12	24	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$		10	20		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ 10 A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$		36	70		
Fall Time	t <sub>f</sub>	1 1		9	18		
Drain-Source Body Diode and Schottky	Characterist	tics			· .		
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C			7		
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A		0.44	0.53	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			28	55	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			21	42	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	I <sub>F</sub> = 13 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C –		15			
Reverse Recovery Rise Time	t <sub>b</sub>	1		13		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

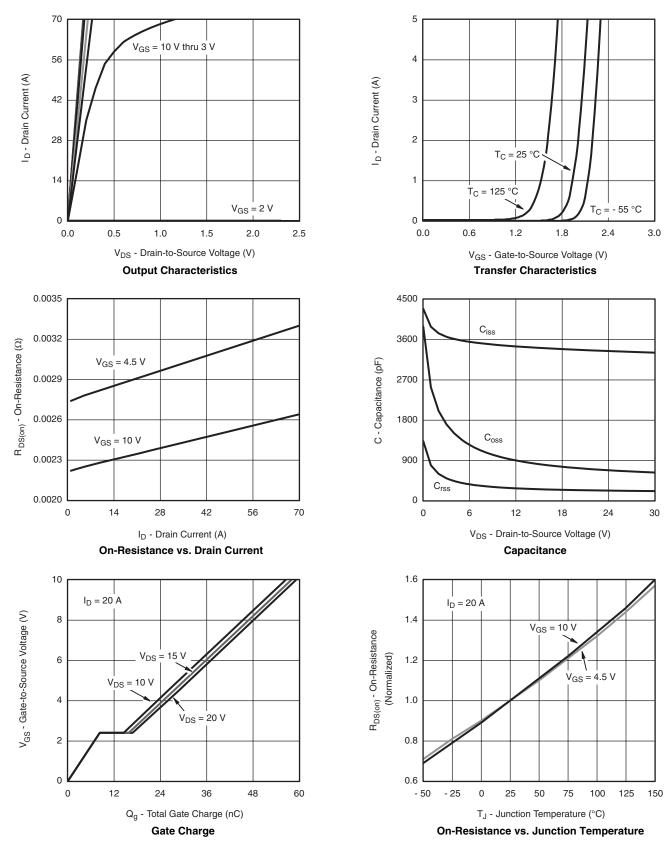
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



# Si4628DY

Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



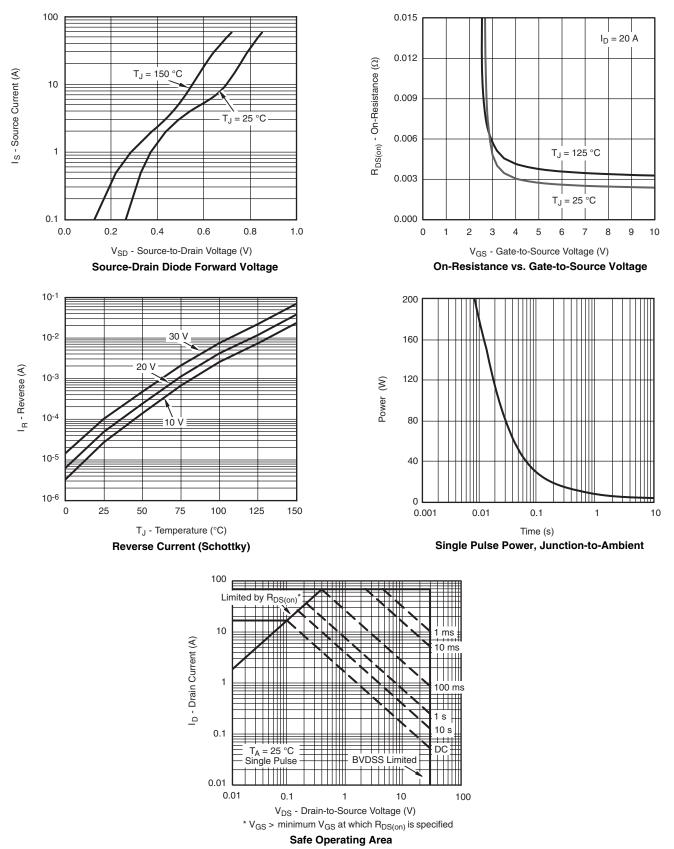
Document Number: 64811 S09-0871-Rev. A, 18-May-09

## Si4628DY

#### Vishay Siliconix



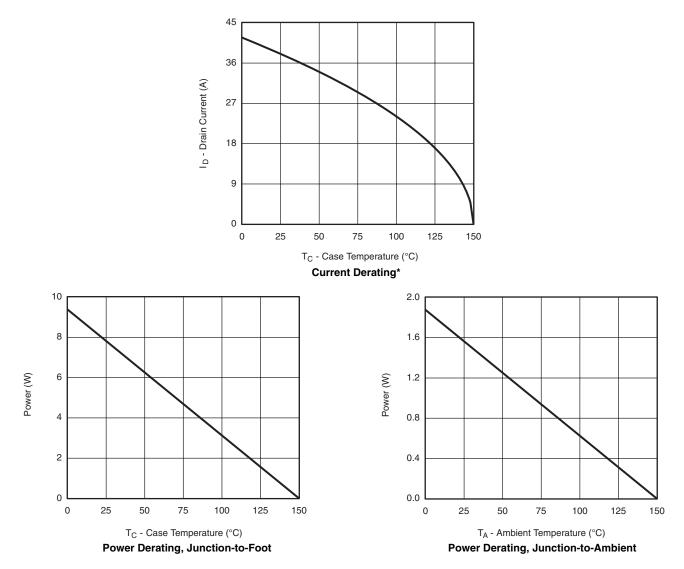
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Si4628DY Vishay Siliconix

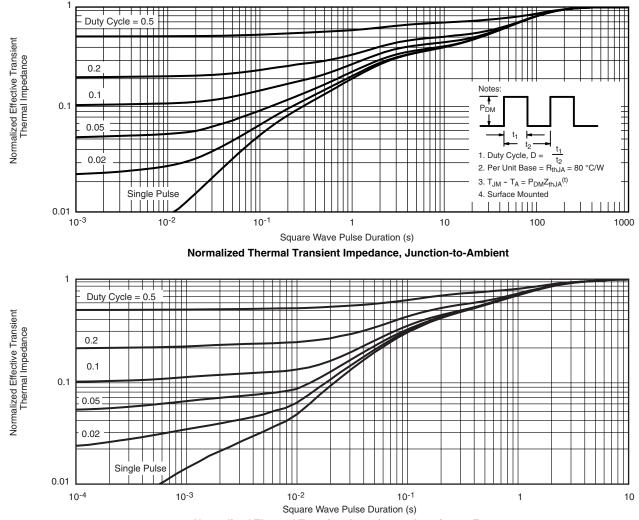
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

#### **Vishay Siliconix**

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?64811">www.vishay.com/ppg?64811</a>.



# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay: SI4628DY-T1-GE3